

Kingbright

SUBMINIATURE SOLID STATE LAMP

AM27ID09

HIGH EFFICIENCY RED

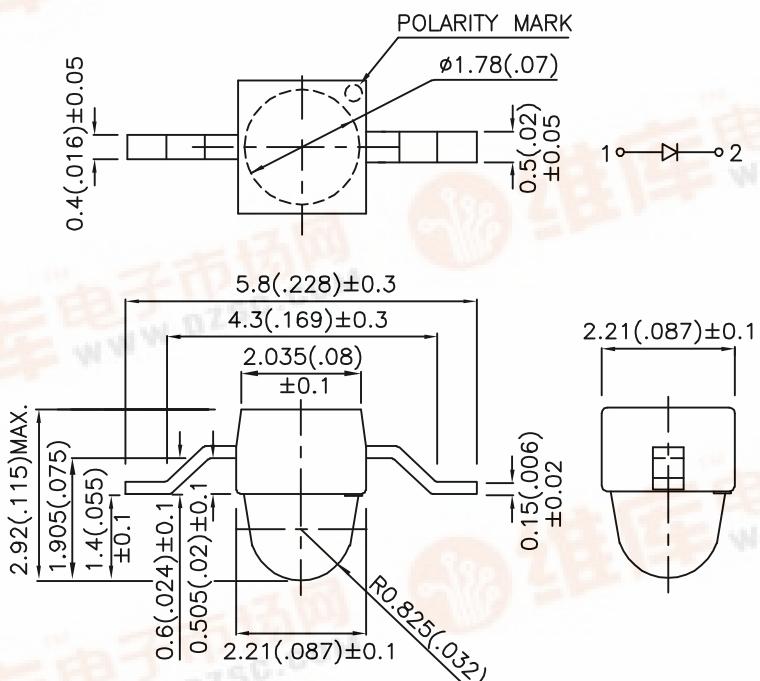
Features

- SUBMINIATURE PACKAGE.
 - WIDE VIEWING ANGLE.
 - Z-BEND LEAD.
 - LONG LIFE - SOLID STATE RELIABILITY.
 - LOW PACKAGE PROFILE.
 - PACKAGE : 1000PCS / REEL.
 - RoHS COMPLIANT.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions



Notes:

- Notes:

 1. All dimensions are in millimeters (inches).
 2. Tolerance is ± 0.25 (0.01") unless otherwise noted.
 3. Lead spacing is measured where the leads emerge from the package.
 4. Specifications are subject to change without notice.



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Selection Guide

Part No.	Dice	Lens Type	I _v (mcd) @ 20mA		Viewing Angle
			Min.	Typ.	
AM27ID09	HIGH EFFICIENCY RED (GaAsP/GaP)	RED DIFFUSED	7	30	2θ1/2

Note:

1. $\theta_{1/2}$ is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	High Efficiency Red	627		nm	I _F =20mA
λ_D	Dominant Wavelength	High Efficiency Red	625		nm	I _F =20mA
$\Delta\lambda 1/2$	Spectral Line Half-width	High Efficiency Red	45		nm	I _F =20mA
C	Capacitance	High Efficiency Red	15		pF	V _F =0V;f=1MHz
V _F	Forward Voltage	High Efficiency Red	2.0	2.5	V	I _F =20mA
I _R	Reverse Current	High Efficiency Red		10	uA	V _R = 5V

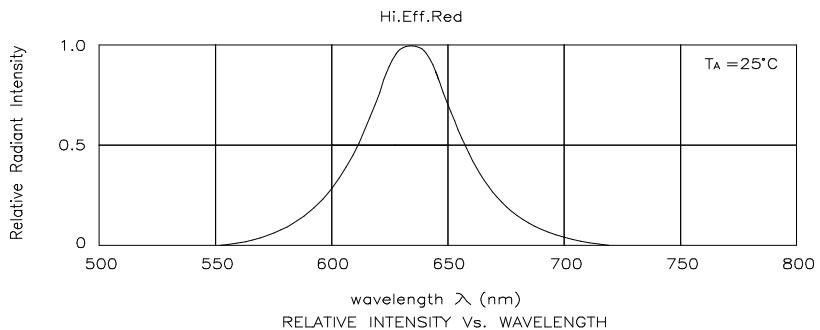
Absolute Maximum Ratings at T_A=25°C

Parameter	High Efficiency Red	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	160	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

Note:

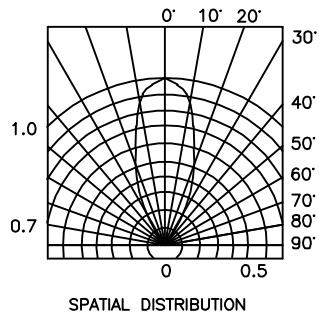
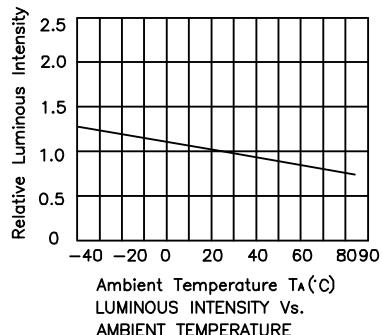
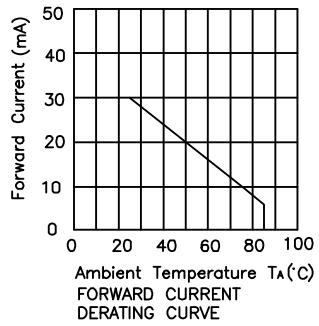
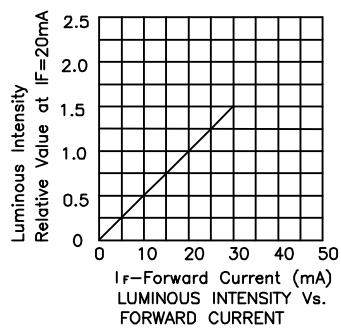
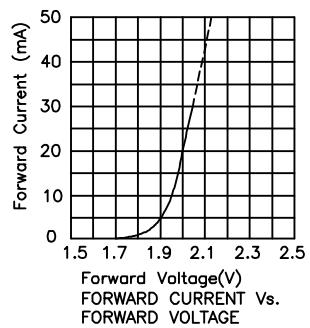
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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High Efficiency Red

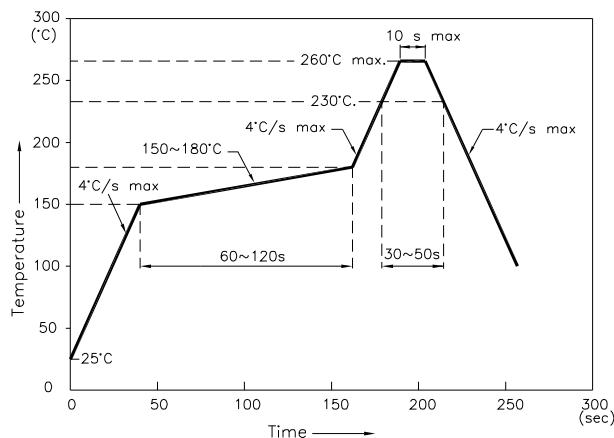
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Reflow Soldering Profile For Lead-free SMT Process.

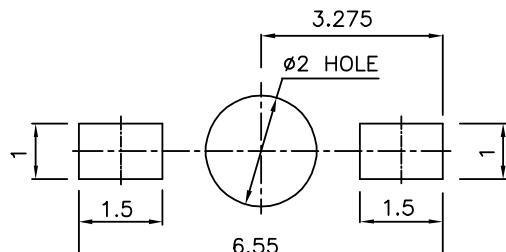


NOTES:

1. We recommend the reflow temperature 245°C ($+/-5^{\circ}\text{C}$). The maximum soldering temperature should be limited to 260°C .
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

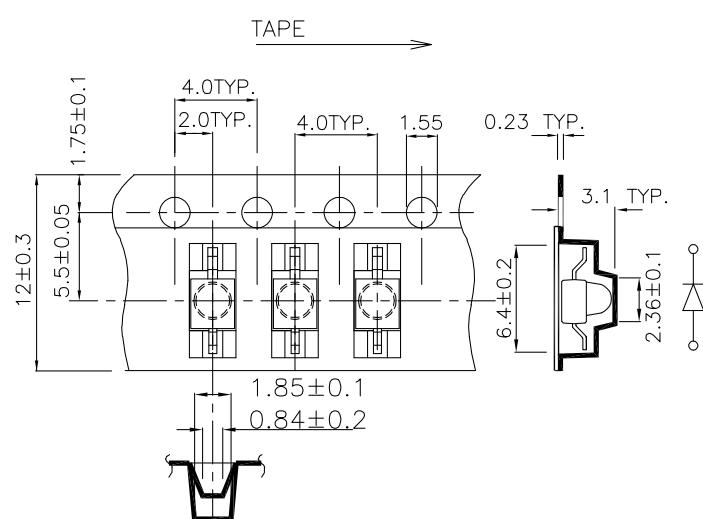
Recommended Soldering Pattern

(Units : mm)



Tape Specifications

(Units : mm)



Remarks:

- If there is sorting requirement (eg. forward voltage, luminous intensity or wavelength), the condition as follows:
1. Wavelength: $+/-1\text{nm}$ (Test condition is based on the sorting standard).
 2. Luminous intensity: $+/-15\%$ (Test condition is based on the sorting standard).
 3. Forward voltage: $+/-0.1\text{V}$ (Test condition is based on the sorting standard).